

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY
CONVEYING PARTY DATA	
Name	Execution Date
COMERICA BANK	10/16/2012
RECEIVING PARTY DATA	
Name:	NEXX SYSTEMS, INC.
Street Address:	900 Middlesex Turnpike
Internal Address:	Building 6
City:	Billerica
State/Country:	MASSACHUSETTS
Postal Code:	01821
PROPERTY NUMBERS Total: 20	
Property Type	Number
Application Number:	10971726
Application Number:	11155008
Application Number:	11716538
Patent Number:	6174011
Patent Number:	6217272
Patent Number:	6251250
Patent Number:	6328858
Patent Number:	6396024
Patent Number:	6530733
Patent Number:	6540899
Patent Number:	6682288
Patent Number:	6821912
Patent Number:	7100954
Patent Number:	7722747

Patent Number:	7445697
Application Number:	12702860
Application Number:	12901173
Application Number:	12790264
Application Number:	12786219
Patent Number:	7727366

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	036703-1181 NEXX SYSTEMS
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NAME OF SUBMITTER:	Erin O'Brien
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Total Attachments: 3

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RELEASE OF SECURITY INTEREST

This Release of Security Interest is made as of October 16, 2012 by COMERICA BANK ("Bank") in favor of Nexx Systems, Inc., a Delaware Corporation, with its principal place of business at 900 Middlesex Turnpike, Building 6, Billerica, MA 01821 ("Company").

Recital

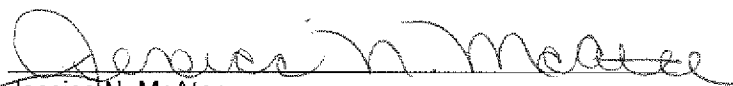
WHEREAS, COMPANY assigned certain interests in the patents described on Exhibit A and attached hereto, respectively (collectively, the "Intellectual Property") to BANK under an Intellectual Property Security Agreement dated as of June 25, 2010 and again on June 10, 2011, and recorded with the US Patent and Trademark Office as set forth on Exhibit A.

WHEREAS, COMPANY has satisfied all its obligations to BANK in the Intellectual Property Security Agreement, and BANK wishes to release its security interest in the Intellectual Property.

Agreement

Now Therefore, BANK agrees that it terminates and releases its security interest in the Intellectual Property and reassigns to COMPANY, without warranty or recourse, all interest of BANK in the Intellectual Property.

BANK: COMERICA BANK


Jessica N. McAtee
First Level Officer
October 16, 2012

Address:
Comerica Bank
CLS Collateral Services, MC 7575
39200 Six Mile Road
Livonia, MI 48152

EXHIBIT A

Assignee Name	Title	Patent/Application No.
Nexx Systems, Inc.	Method and apparatus for fluid processing a workpiece	10/971,726
Nexx Systems, Inc.	Method and apparatus for fluid processing and drying a workpiece	11/155,008
Nexx Systems, Inc.	Substrate processing pallet with cooling	11/716,538
Nexx Systems, Inc.	Method of and apparatus for handling thin and flat workpieces and the like	6,174,011
Nexx Systems, Inc.	In-line sputter deposition system	6,217,272
Nexx Systems, Inc.	Method of and apparatus for controlling fluid flow and electric fields involved in the electroplating of substantially flat workpieces and the like and more generally controlling fluid flow in the processing of other work piece surfaces as well	6,251,250
Nexx Systems, Inc.	Multi-layer sputter deposition apparatus	6,328,858
Nexx Systems, Inc.	Permanent magnet ECR plasma source with integrated multipolar magnetic confinement	6,396,024
Nexx Systems, Inc.	Substrate processing pallet and related substrate processing method and machine	6,530,733
Nexx Systems, Inc.	Method of and apparatus for fluid sealing, while electrically contacting, wet-processed workpieces	6,540,899
Nexx Systems, Inc.	Substrate processing pallet and related substrate processing method and machine	6,682,288
Nexx Systems, Inc.	Substrate processing pallet and related substrate processing method and machine	6,821,912
Nexx Systems, Inc.	Ultra-thin wafer handling system	7,100,954
Nexx Systems, Inc.	Method and apparatus for fluid processing a workpiece	7,722,747
Nexx Systems, Inc.	Method and apparatus for fluid processing a workpiece	7,445,697
Nexx Systems, Inc.	Method and apparatus for fluid processing a workpiece	7,722,747

EXHIBIT A CONTINUED

Assignee Name	Title	Patent/Application No.
Nexx Systems, Inc.	Wetting a Workpiece Surface in a Fluid Processing System	12,702,860
Nexx Systems, Inc.	Substrate Processing Pallet with Cooling	12,901,173
Nexx Systems, Inc.	Balancing Pressure to Improve a Fluid Seal	12,790,264
Nexx Systems, Inc.	Method and Apparatus for Fluid Processing a Workpiece	12,786,219
Nexx Systems, Inc.	Balancing Pressure to Improve a Fluid Seal	7727366

Bank's security interest recorded at the US Patent and Trademark Office on June 28, 2010 and June 23, 2011 at Reel and Frame Number 024599/0050 and at Reel and Frame Number 026480/0576.